MBR2H100SFT3G, NRVB2H100SFT3G

Schottky Power Rectifier, Surface Mount

2.0 A, 100 V, SOD-123FL Package

This device uses the Schottky Barrier principle with a large area metal-to-silicon power diode. Ideally suited for low voltage, high frequency rectification or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. Because of its small size, it is ideal for use in portable and battery powered products such as cellular and cordless phones, chargers, notebook computers, printers, PDAs and PCMCIA cards. Typical applications are AC-DC and DC-DC converters, reverse battery protection, and "Oring" of multiple supply voltages and any other application where performance and size are critical.

Features

- Guardring for Stress Protection
- Low Forward Voltage
- 175°C Operating Junction Temperature
- Epoxy Meets UL 94 V-0
- Package Designed for Optimal Automated Board Assembly
- ESD Ratings: Machine Model, C
 - Human Body Model, 3B
- NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Mechanical Characteristics

- Reel Options: MBR2H100SFT3G = 10,000 per 13 in reel/8 mm tape
- Device Marking: L2H
- · Polarity Designator: Cathode Band
- Weight: 11.7 mg (approximately)
- Case: Epoxy, Molded
- Lead Finish: 100% Matte Sn (Tin)
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL 1 Requirements



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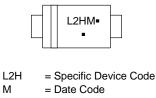
http://onsemi.com

SCHOTTKY BARRIER RECTIFIER 2.0 AMPERES **100 VOLTS**



SOD-123FL **CASE 498**

MARKING DIAGRAM



= Pb-Free Package

Μ

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
MBR2H100SFT3G	SOD-123 (Pb-Free)	10000 / Tape & Reel
NRVB2H100SFT3G	SOD-123 (Pb-Free)	10000 / Tape & Reel

+For information on tape and reel specifications,

including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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MAXIMUM RATINGS

Rating		Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	100	V
Average Rectified Forward Current $(T_L = 146^{\circ}C)$	lo	2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	50	A
Storage and Operating Junction Temperature Range (Note 1)	T _{stg} , T _J	-65 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The heat generated must be less than the thermal conductivity from

Junction–to–Ambient: $dP_D/dT_J < 1/R_{\theta JA}$.

THERMAL CHARACTERISTICS

Characteristic		Value	Unit
Thermal Resistance, Junction-to-Lead (Note 2)	Ψ_{JCL}	23	°C/W
Thermal Resistance, Junction-to-Ambient (Note 2)	R_{\thetaJA}	85	°C/W
Thermal Resistance, Junction-to-Ambient (Note 3)	R_{\thetaJA}	330	°C/W

ELECTRICAL CHARACTERISTICS

Characteristic		Value	Unit
	V _F	0.76 0.84 0.61 0.68	V
Maximum Instantaneous Reverse Current (Note 4) (Rated dc Voltage, $T_J = 25^{\circ}C$) (Rated dc Voltage, $T_J = 125^{\circ}C$)	Ι _R	40 0.5	μA mA

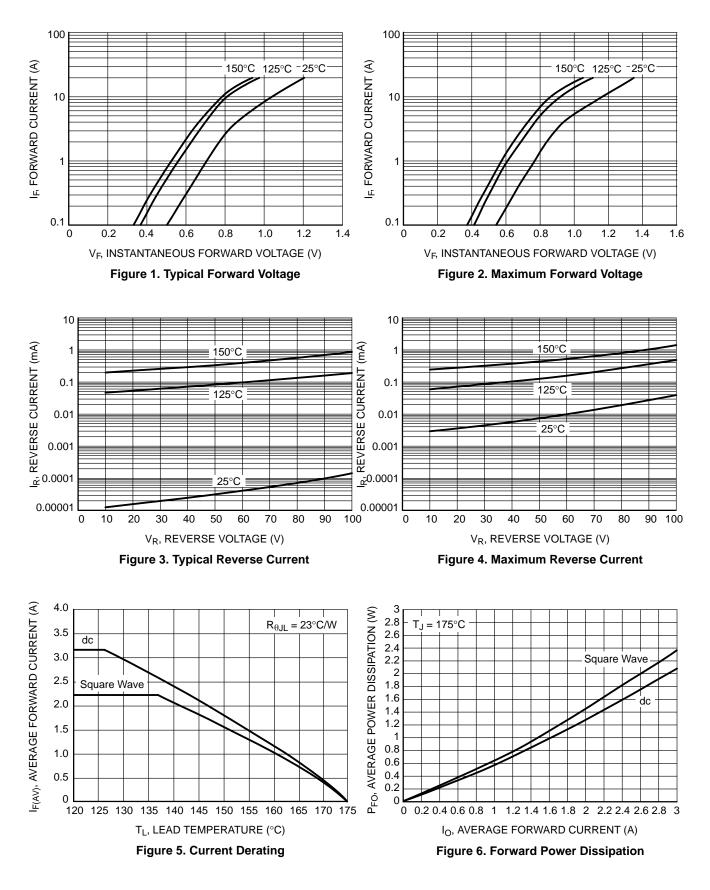
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Mounted with 700 mm² copper pad size (Approximately 1 in²) 1 oz FR4 Board.

3. Mounted with pad size approximately 20 mm² copper, 1 oz FR4 Board.

4. Pulse Test: Pulse Width \leq 380 µs, Duty Cycle \leq 2.0%.

MBR2H100SFT3G, NRVB2H100SFT3G

TYPICAL CHARACTERISTICS



MBR2H100SFT3G, NRVB2H100SFT3G



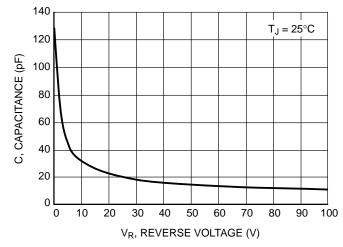
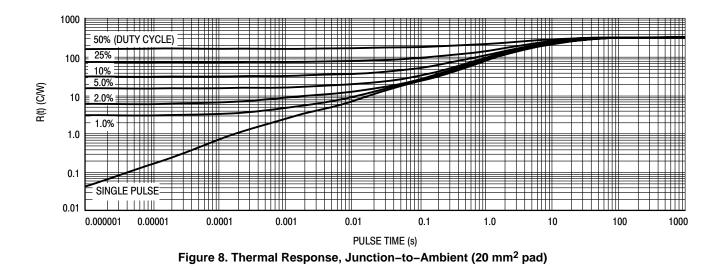


Figure 7. Capacitance



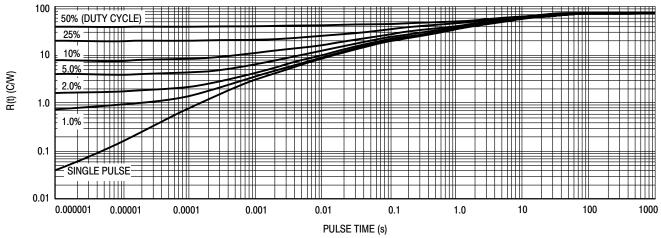


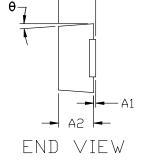
Figure 9. Thermal Response, Junction-to-Ambient (1 in² pad)

SOD-123-2 1.65x2.70x0.90 F D 2 1

TOP VIEW

— Н_Е

SIDE VIEW



	MILLIMETERS		
DIM	MIN.	NDM.	MAX.
А	0.90	0.95	0.98
A1	0.00	0.05	0.10
A2	0.85	0.90	0.95
Q	0.70	0.90	1.10
С	0.10	0.15	0.20
D	1.50	1.65	1.80
E	2.50	2.70	2.90
E1	1.70	2.10	2.50
Η _E	3.40	3.60	3.80
L	0.55	0.75	0.95
θ	0°		8•

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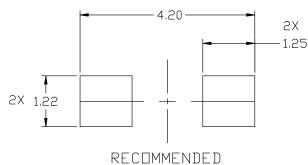
DATE 22 AUG 2023

NDTES:

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-2X L

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- DIMENSIONS 6 AND L ARE TO BE MEASURED ON A З. FLAT SECTION OF THE LEAD BETWEEN 0.10 AND 0.25 FROM THE LEAD TIP.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH PROTRUSIONS, OR GATE BURRS.
- 5. FLAT LEAD.



MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



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GENERIC **MARKING DIAGRAM***

-E1-BOTTOM VIEW



XXX = Specific Device Code = Date Code Μ

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

А

CASE 498 ISSUE E

2X b

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